DATA SHEET

MB501L/504/504L TWO MODULUS PRESCALERS

TWO MODULUS PRESCALERS

The Fujitsu MB501L/504/504L are two modulus prescalers, which are use with a frequency synthesizer to make a PLL (Phase Locked Loop). They will divide the input frequency by the modulus of 64/65 or 128/129 for the MB501L, and 32/33 or 64/65 for the MB504/MB504L. The MB501L and MB504L are low-power versions. The output of 1.6V peak to peak on ECL level applies to all.

• High Operating Frequency, Low Power Operation:

1.1GHz at 50mW typ. (MB501L) 520MHz at 50mW typ. (MB504)

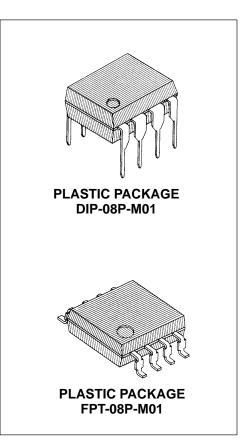
520MHz at 25mW typ. (MB504L)

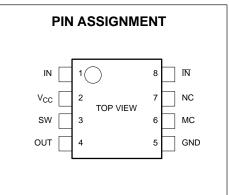
- Pulse Swallow Function
- Wide Operation Temperature $T_A = -40^{\circ}C$ to $+85^{\circ}C$
- Stable Output Amplitude: V_{OUT} = 1.6Vp-p
- Complete PLL synthesizer circuit with the Fujitsu MB87001A, PLL synthesizer IC
- Plastic 8-pin Standard Dual-In-Line Package or space saving Flat Package

ABSOLUTE MAXIMUM RATINGS (see NOTE)

Rating	Symbol	Value	Unit
Supply Voltage	V _{CC}	-0.5 to +7.0	V
Input Voltage	V _{IN}	-0.5 to V_{CC}	V
Output Current	Vo	10	mA
Ambient Temperature	T _A	-40 to +85	°C
Storage Temperature	T _{STG}	– 55 to +125	°C

Note: Permanent device damage may occur if the above **Absolute Maximum Ratings** are exceeded. Functional operation should be restricted to the conditions as detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields. However, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit.

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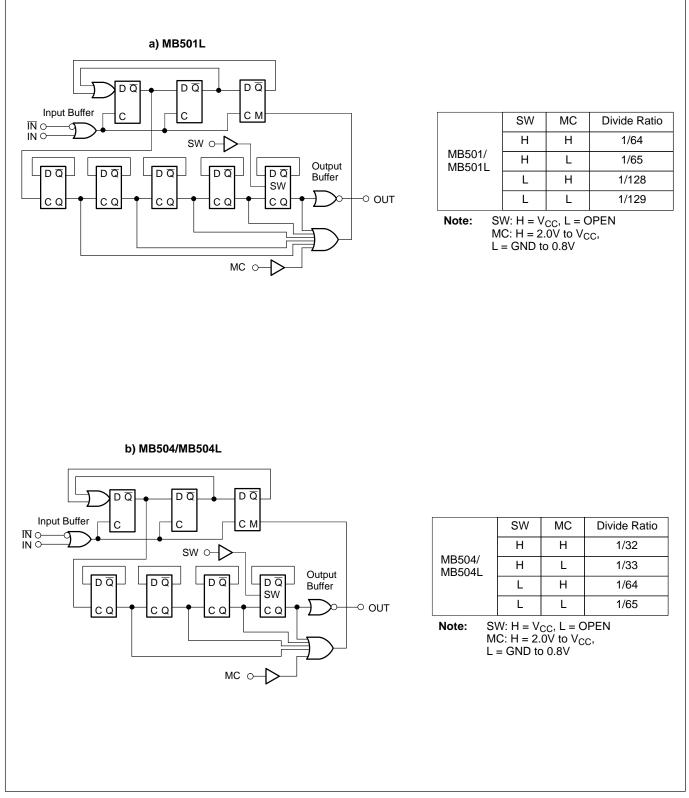


Figure 1. Block Diagrams

PIN DESCRIPTION

Pin Number	Symbol	Function	
1	IN	Input	
2	V _{CC}	DC Supply Voltage	
3	SW	Divide Ratio Control Input (See Divide Ratio Table)	
4	OUT	Output	
5	GND	Ground	
6	MC	Modulus Control Input (See Divide Ratio Table)	
7	NC	Non Connection	
8	ĪN	Complementary Input	

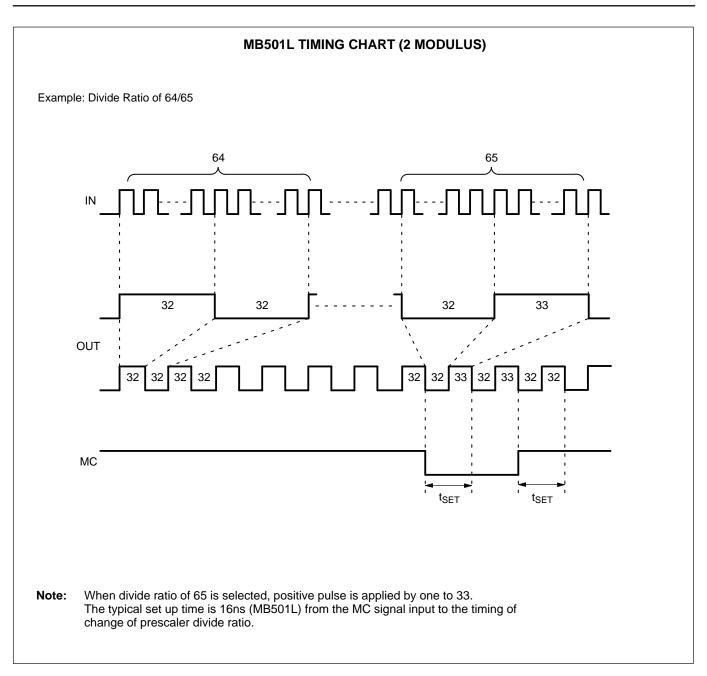
RECOMMENDED OPERATING CONDITIONS

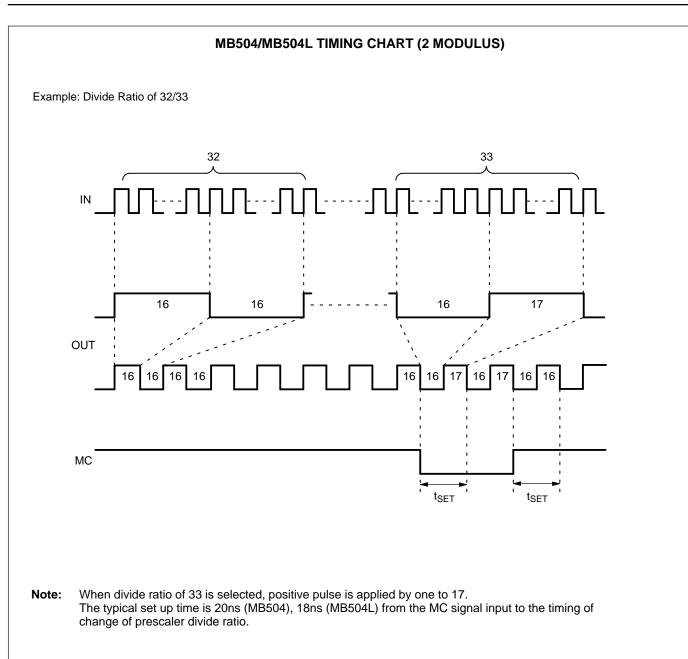
Parameter	Symbol		Unit		
		Min.	Тур.	Max.	Unit
Supply Voltage	V _{CC}	4.5	5.0	5.5	V
Output Current	lo		1.2		mA
Ambient Temperature	T _A	-40		+85	°C
Load Capacitance	CL			12	pF

ELECTRICAL CHARACTERISTICS (Recommended Operating Conditions unless otherwise noted)

Parameter		Symbol Cor	O an diday a		Value		
			Conditions	Min.	Тур.	Max.	Unit
Power Supply Current	MB501L	Icc	I/O pins are open		10	14*	mA
	MB504				10	14*	mA
	MB504L				5	7*	mA
Output Amplitude		Vo		1.0	1.6		V _{P-P}
Input Frequency	MB501L		With input coupling capacitor 1000pF	10		1100	MHz
	MB504	f _{IN}		10		520	MHz
	MB504L			10		520	MHz
Input Signal Amplitude for IN	MB501L	P _{IN}		-4		5.5	dBm
	MB504			-12		10	dBm
	MB504L			-12		10	dBm
High Level Input Voltage for MC		V _{IHM}		2.0			V
Low Level Input Voltage for MC		V _{ILM}				0.8	V
High Level Input Voltage for SW	,	V _{IHS} **		V _{CC} -0.1	V _{CC}	V _{CC} +0.1	V
Low Level Input Voltage for SW		V _{ILS}			OPEN		V
High Level Input Current for MC	:	Інм	V _{IH} = 2.0V			0.4	mA
Low Level Input Current for MC		I _{ILM}	V _{IL} = 0.8V	-0.2			mA
Modulus Set-up Time MC to OUT	MB501L				16	26	ns
	MB504	t _{SET}			20	30	ns
	MB504L				18	28	ns

* V_{CC} = 5V, T_A = 25°C ** Design Guarantee Note:





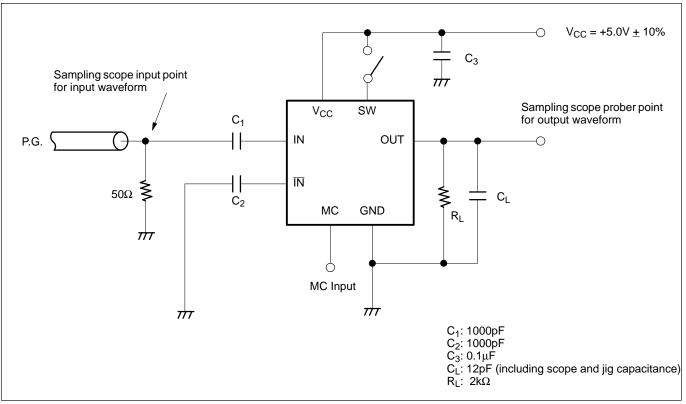


Figure 2. Test Circuit

TYPICAL CHARACTERISTICS CURVES

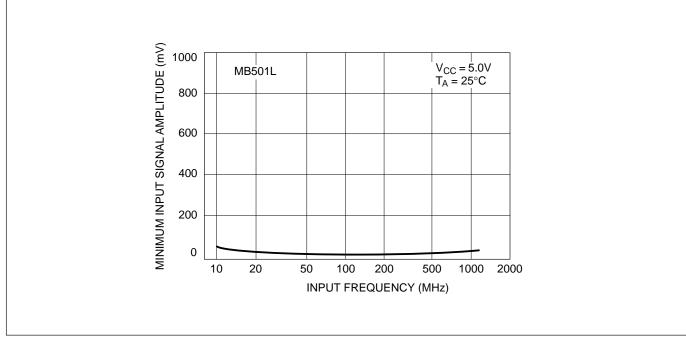


Figure 3. Input Signal Amplitude vs. Input Frequency

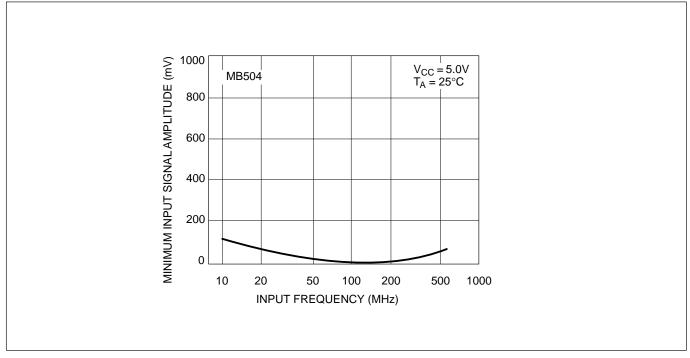
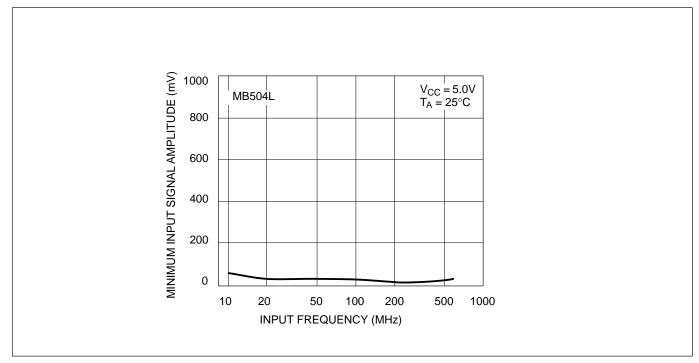


Figure 4. Input Signal Amplitude vs. Input Frequency



TYPICAL CHARACTERISTICS CURVES (Continued)

Figure 5. Input Signal Amplitude vs. Input Frequency

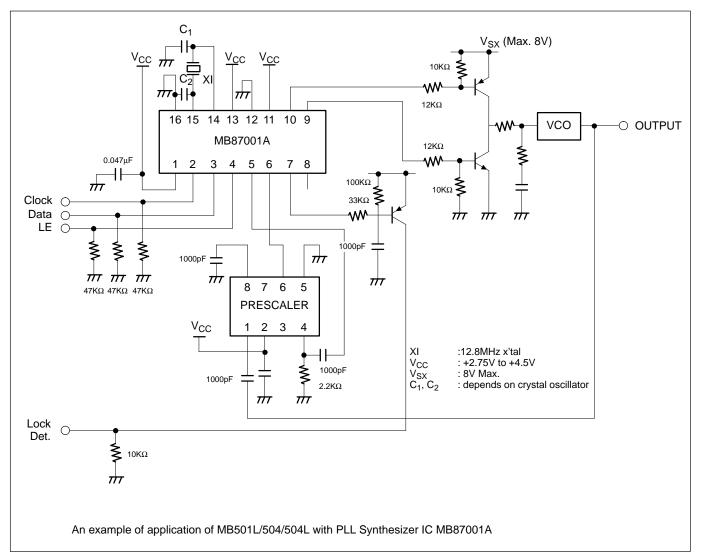
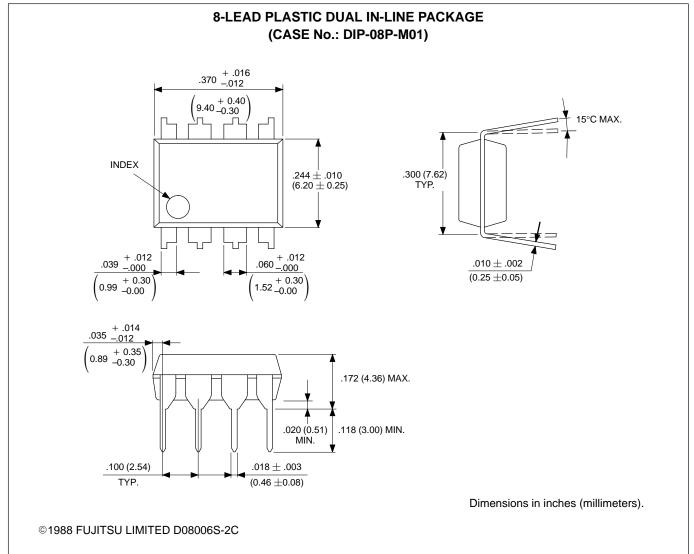
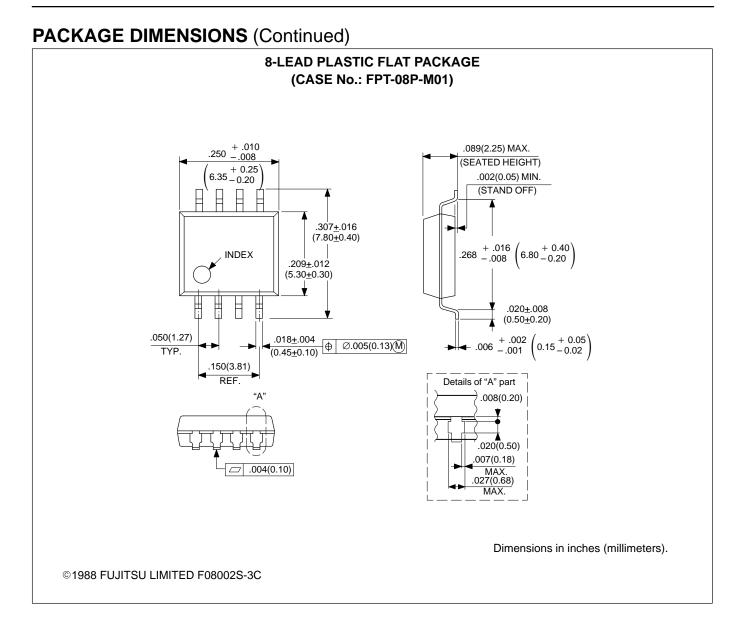


Figure 6. Typical Application Example

PACKAGE DIMENSIONS





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Circuit diagrams utilizing Fujitsu products are included as a means of illustrating typical semiconductor applications. Complete information sufficient for construction purposes is not necessarily given.

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MB501L MB504 MB504L